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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Soo Min LEE	06/10/2008
Hee Seok PARK	06/10/2008
Jae Woong HAN	06/10/2008
Seong Suk LEE	06/10/2008
Cheol Soo SONE	06/10/2008

RECEIVING PARTY DATA

Name:	SAMSUNG ELECTRO-MECHANICS CO., LTD.	
Street Address:	314 Maetan3-Dong, Yeongtong-Gu, Suwon,	
City:	Gyunggi-do,	
State/Country:	REPUBLIC OF KOREA	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12188698

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	069576-0396
NAME OF SUBMITTER:	Hosang Lee

Total Attachments: 2

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PATENT REEL: 021363 FRAME: 0003

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PATENT REEL: 021363 FRAME: 0004

RECORDATION FORM COVER SHEET			
Docket No.: 069576-0396 PATENTS ONLY			
To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.			
1. Name of Conveying Party(ies)	2. Name and address of receiving party(ies)		
Soo Min LEE, Hee Seok PARK, Jae Woong HAN, Seong Suk	Name: SAMSUNG ELECTRO-MECHANICS CO.,		
LEE, Cheol Soo SONE	LTD.		
	Internal Address:		
Additional name(s) of conveying party(ies) attached? Yes No			
3. Nature of Conveyance/Execution Date(s)	Address: 314 Maetan3-Dong, Yeongtong-Gu, Suwon,		
	Gyunggi-do, REPUBLIC OF KOREA		
Execution Date(s): June 10, 2008			
✓ Assignment ✓ Merger			
Security Agreement Change of Name			
☐ Joint Research Agreement			
Government Interest Assignment			
Executive Order 9424, Confirmatory License			
Other	Additional name(s) & address(es) attached? Yes No		
4. Application or patent number(s):	☐ This document is being filed together with a new application.		
A. Patent Application No(s).	B. Patent No(s).		
Additional numbers attached? Yes No			
5. Name and address to whom correspondence concerning	6. Total number of applications and patents		
document should be mailed:	involved:		
Name: MCDERMOTT WILL & EMERY LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00		
Internal Address:	Authorized to be charged by credit card		
	Authorized to be charged to deposit account		
Street Address: 600 13th Street, N.W.	☐ Enclosed		
	None required (government interest not affecting title)		
City: Washington State: D. C. Zip: 20005-3096			
Phone Number: 202.756.8000	8. Payment Information:		
Fax Number: 202.756.8087			
Email Address:	a. Credit Card Last 4 Numbers		
	Expiration Date b. Deposit Account Number 500417		
	Authorized User Name		
9. Signature.	- 411		
Hosang Lee L00,295	August 8, 2008		
Name and Registration No. of Person Signing	Signature Date		
Total number of pages including cover sheet, attachments and documents: 2			

PATENT REEL: 021363 FRAME: 0005

Zoonogath					
(SAB) Docket No.:					
	ASSIGNMENT				
	In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,				
(1) LEE, Soo Min (5) (2) PARK, Hee Seok (6) (3) HAN, Jae Woong (7)					
(4) LEE, Seong Suk (8					
who have made a certain new and useful invention, hereby sell, assign and transfer unto SAMSUNG ELECTRO-MECHANICS CO., LTD.					
314 Maetan3-Dong, Yeongtong-Gu, Suwon, Gyung	gi-do, Republic of Korea				
its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled NITRIDE SEMICONDUCTOR DEVICE					
(a) for which an application for United States Letters Patent was filed on, and identified by United States Serial No; or					
(b) for which an application for	United States Letters Patent was executed on				
and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE; AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.					
SIGNED on the dates indicated aside our signatures					
INVENTORS	DATE SIGNED				
1) Name: LEE, Soo Min	06/10/2008				
2) Park hoe blok Name: PARK, Hee Seok	0611012008				
Name: HAN, Jae Woong	06/10/2008				
4) Name: LEE, Seong Suk	06/10/2008				

PATENT REEL: 021363 FRAME: 0006

06/10/2008

RECORDED: 08/08/2008

Name: SONE, Cheol Soo